

## PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6758855

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
HARUHIKO FURUKAWA	08/02/2019
TOMOHIRO IIMURA	07/30/2019
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	DOW TORAY CO., LTD.
<b>Street Address:</b>	2-24, HIGASHI-SHINAGAWA 2-CHOME
<b>City:</b>	SHINAGAWA-KU, TOKYO
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	140-8617
<b>PROPERTY NUMBERS Total: 2</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	17413087
<b>Application Number:</b>	62779240
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Email:</b>	patents@wnj.com
<b>Correspondent Name:</b>	WARNER, NORCROSS + JUDD LLP
<b>Address Line 1:</b>	150 OTTAWA AVE. NW, SUITE 1500
<b>Address Line 4:</b>	GRAND RAPIDS, MICHIGAN 49503-2832
<b>ATTORNEY DOCKET NUMBER:</b>	157928.183666 (82671)
<b>NAME OF SUBMITTER:</b>	WYATT J. ISTVAN-MITCHELL
<b>SIGNATURE:</b>	/Wyatt J. Istvan-Mitchell/
<b>DATE SIGNED:</b>	06/11/2021
<b>Total Attachments: 2</b>	
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This Assignment 110 is in the ENGLISH language and has the same meaning in other languages with the same 110 number and R/Date

FORM 110 (R 5/97)

I/we verily believe I am/we are the original, first and sole/joint inventor(s) of the subject matter which is embraced by and for which a patent is sought on the invention entitled: **SILICONE ADHESIVE COMPOSITION AND A USE THEREOF**

Dow Toray Co., Ltd.  
2-2-24 Higashi-Shinagawa  
Shinagawa-ku, Tokyo 140-8617, Japan

an entity organized and existing under the laws of the state of Japan (hereinafter referred to as the "Assignee"); my/our entire right, title and interest throughout the world, in and to the invention and all rights and powers to make applications, including provisional applications when permitted by law, for Letters Patent in its own name, or in the name of its designee (or nominee(s)); and all rights and powers to file any corresponding or equivalent applications in any and all countries, including all rights to claim priority under all United States domestic laws, International Convention(s) and Treaties in the name of Assignee, and do hereby authorize Assignee or its designee to insert here the Priority Number, Filing Date, and Filing Country

Priority Number	Filing Date	Filing Country
62 / 779 240	Month date, 13 Dec 2018	United States of America

I/we authorize Assignee or its designee to translate this Assignment into all languages necessary; and we request that any such Letters Patent be issued to Assignee; and consent to the recordal of this Assignment, or a Notarial True Copy thereof, being under covenant not only that I/we have full power to make the same, but also that such assigned rights are not encumbered by any grant, license, or other right heretofore given.

Subscribed and Declared by me/us:

At: Chiba, Japan  
 this 2 day of Aug, 20 19  
 Effective as of December 13, 2018

Signature: Haruhiko Furukawa  
 Full Name: FURUKAWA, HARUHIKO  
 Mailing Address: c/o Dow Toray Co., Ltd.  
 2-2 Chigusa Kaigan  
 Ichihara-shi, Chiba 299-0108  
 Japan

At: \_\_\_\_\_  
this \_\_\_\_\_ day of \_\_\_\_\_, 20 \_\_\_\_\_  
Signature: \_\_\_\_\_  
Full Name: \_\_\_\_\_  
Mailing Address: \_\_\_\_\_

At: \_\_\_\_\_  
this \_\_\_\_\_ day of \_\_\_\_\_, 20 \_\_\_\_\_

Signature: \_\_\_\_\_  
Full Name: \_\_\_\_\_  
Mailing Address: \_\_\_\_\_

At: \_\_\_\_\_  
this \_\_\_\_\_ day of \_\_\_\_\_, 20\_\_\_\_  
Signature: \_\_\_\_\_  
Full Name: \_\_\_\_\_  
Mailing Address: \_\_\_\_\_

At: \_\_\_\_\_  
this \_\_\_\_\_ day of \_\_\_\_\_, 20 \_\_\_\_\_  
Signature: \_\_\_\_\_  
Full Name: \_\_\_\_\_  
Mailing Address: \_\_\_\_\_

At: \_\_\_\_\_  
this \_\_\_\_\_ day of \_\_\_\_\_, 20 \_\_\_\_\_  
Signature: \_\_\_\_\_  
Full Name: \_\_\_\_\_  
Mailing Address: \_\_\_\_\_

# INDIVIDUAL ASSIGNMENT AND INVENTOR'S DECLARATION

(with Priority Rights)

I/we verily believe I am/we are the original, first and sole/joint inventor(s) of the subject matter which is embraced by and for which a patent is sought on the invention entitled: **SILICONE ADHESIVE COMPOSITION AND A USE THEREOF**

which invention was made and invented by me/us out of and in the course of my/our employment with my/our respective employers as stated below my/our name(s). I/we acknowledge that I/we hold the invention and all patent and other rights and powers obtainable or exercisable in respect thereof in trust for our respective employers. As trustee(s), and for good and valuable consideration and/or the remuneration received for my/our work, I/we sell, assign and transfer unto:

Dow Toray Co., Ltd.  
2-2-24 Higashi-Shinagawa  
Shinagawa-ku, Tokyo 140-8617, Japan

an entity organized and existing under the laws of the state of Japan (hereinafter referred to as the "Assignee"); my/our entire right, title and interest throughout the world, in and to the invention and all rights and powers to make applications, including provisional applications when permitted by law, for Letters Patent in its own name, or in the name of its designee (or nominee(s)); and all rights and powers to file any corresponding or equivalent applications in any and all countries, including all rights to claim priority under all United States domestic laws, International Convention(s) and Treaties in the name of Assignee, and do hereby authorize Assignee or its designee to insert here the Priority Number, Filing Date, and Filing Country

Priority Number	Filing Date	Filing Country
62 / 779,240	Month date, 13 Dec 2018	United States of America

of the application, on which the claim for priority will be based; and in and to any Letters Patent that may be issued for the invention in any and all countries. I/we do hereby agree to assist Assignee in the prosecution of the application(s) and in any interference, conflict, opposition or litigation which may arise involving the invention or the patent or patents thereon, and to execute for any and all countries any document relating to applications derived from, corresponding to or equivalent to the above identified application as Assignee may request.

I/we authorize Assignee or its designee to translate this Assignment into all languages necessary; and we request that any such Letters Patent be issued to Assignee; and consent to the recordal of this Assignment, or a Notarial True Copy thereof, being under covenant not only that I/we have full power to make the same, but also that such assigned rights are not encumbered by any grant, license, or other right heretofore given.

Subscribed and Declared by me/us:

At: Chiba, Japan  
 this 30 day of July, 20 19  
 Effective as of December 13, 2018  
 Signature: Tomohiro Iimura  
 Full Name: IIMURA, TOMOHIRO  
 Mailing Address: c/o Dow Toray Co., Ltd.  
 2-2 Chigusa Kaigan  
 Ichihara-shi, Chiba 299-0108  
 Japan

At: \_\_\_\_\_  
this \_\_\_\_\_ day of \_\_\_\_\_, 20 \_\_\_\_\_

Signature: \_\_\_\_\_

Full Name: \_\_\_\_\_

Mailing Address: \_\_\_\_\_

At: \_\_\_\_\_  
this \_\_\_\_\_ day of \_\_\_\_\_, 20 \_\_\_\_\_

Signature: \_\_\_\_\_  
Full Name: \_\_\_\_\_  
Mailing Address: \_\_\_\_\_

At: \_\_\_\_\_  
this \_\_\_\_\_ day of \_\_\_\_\_, 20 \_\_\_\_\_  
Signature: \_\_\_\_\_  
Full Name: \_\_\_\_\_  
Mailing Address: \_\_\_\_\_

At: \_\_\_\_\_  
this \_\_\_\_\_ day of \_\_\_\_\_, 20 \_\_\_\_\_

Signature: \_\_\_\_\_

Full Name: \_\_\_\_\_

Mailing Address: \_\_\_\_\_

At: \_\_\_\_\_  
this \_\_\_\_\_ day of \_\_\_\_\_, 20 \_\_\_\_\_

Signature: \_\_\_\_\_

Full Name: \_\_\_\_\_

Mailing Address: \_\_\_\_\_